

5mm Bi-Color With Common Anode T-1 3/4 Type LED

Technical Data Sheet

Part No.: LL-509SGM2E-2S-2C



Features:

- \diamond Uniform light output.
- \diamond Low power consumption.
- \diamond I.C. Compatible.
- \diamond Long life-solid state reliability.
- $\diamond~$ The product itself will remain within RoHS compliant version.

Descriptions:

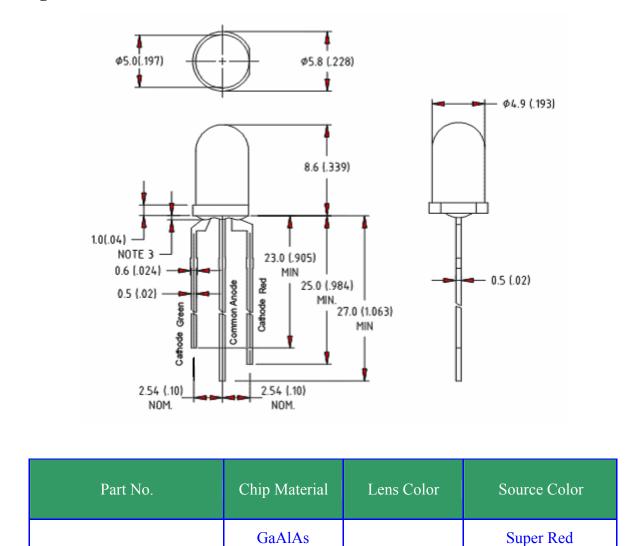
- ♦ The Red source color devices are made with GaAlAs substrate Light Emitting Diode.
- ♦ The Yellow Green source color devices are made with GaP on substrate Light Emitting Diode.

Applications:

- \diamond TV set.
- \diamond Monitor.
- \diamond Telephone.
- \diamond Computer
- ♦ Circuit board, etc.
- \diamond Message boards.
- \diamond Variable message signs(VMS).
- \diamond Commercial outdoor advertising.



Package Dimension:



GaP

| N | otes: | |
|----|-------|--|
| ΤN | ULCS. | |

1. All dimensions are in millimeters (inches).

LL-509SGM2E-2S-2C

- Tolerance is $\pm 0.25(.010'')$ mm unless otherwise noted. 2.
- Protruded resin under flange is 1.0mm(.04") max. 3.
- Specifications are subject to change without notice. 4.

White Diffused

Yellow Green



Absolute Maximum Ratings at Ta=25℃

| Parameters | Symbol | Max. | Unit |
|--|----------------|--------------------|------|
| Power Dissipation | P _D | 100 | mW |
| Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width) | IFP | 100 | mA |
| Hyper Red Chip Forward Current | IF | 30 | mA |
| Blue Chip Forward Current | IF | 30 | mA |
| Reverse Voltage | V _R | 5 | V |
| Operating Temperature Range | Topr | -40°C to +85°C | |
| Storage Temperature Range | Tstg | -40°C to +100°C | |
| Lead Soldering Temperature [4mm(.157") From Body] | Tsld | 260℃ for 5 Seconds | |



| Clectrical Optical Characteristics at Ta=25℃ | | | | | | | |
|--|--------------------|-------------------|------|------|------|------|--------------------|
| Parameters | Symbol | Emitting Color | Min. | Тур. | Max. | Unit | Test Condition |
| Viewing Angle* | $2\theta_{1/2}$ | Super Red | | 60 | | Deg | (Note 2) |
| | | Yellow Green | | 60 | | | |
| Forward Voltage | V _F | Super Red | 1.6 | 1.9 | 2.4 | V | IF =20mA |
| | | Yellow Green | 1.8 | 2.0 | 2.8 | | |
| Reverse Current | I _R | Super Red | | | 10 | μA | V _R =5V |
| | | Yellow Green | | | 10 | | |
| Peak Emission Wavelength | λp | Super Red | | 660 | | nm | IF =20mA |
| | | Yellow Green | | 568 | | | |
| Spectral Line Half-Width | λd | Super Red | | 648 | | | |
| | | Yellow Green | | 572 | | | |
| Spectral Line Half-Width | $	riangle \lambda$ | Super Red | | 30 | | | |
| | | Yellow Green | | 26 | | | |
| Luminous Intensity | Iv | Super Red | 200 | 500 | | mcd | |
| | | Yellow Green | 300 | 600 | | | |

Notes:

- 1. Luminous Intensity Measurement allowance is $\pm 10\%$.
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.



Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

1)Test Items and Results:

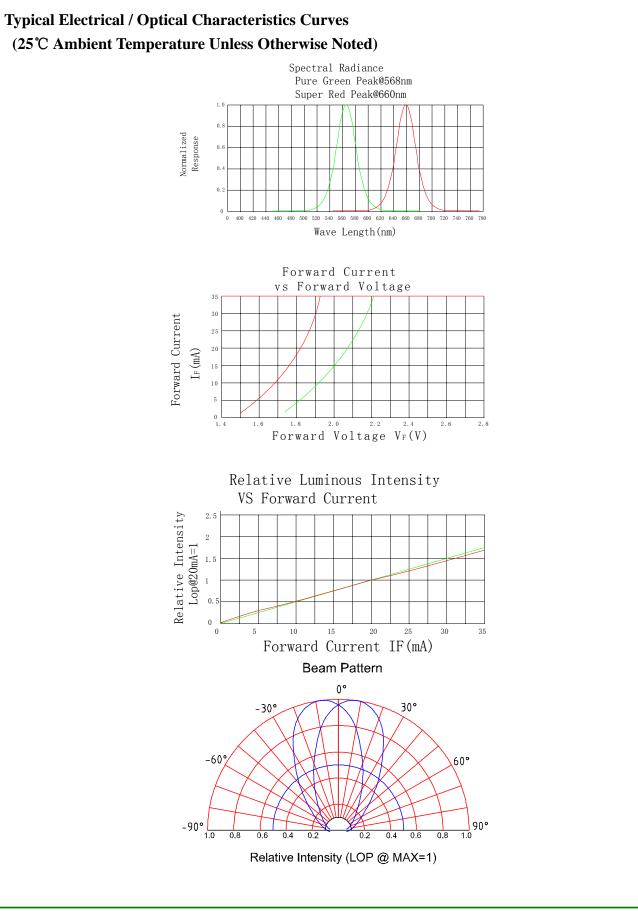
| Test Item | Standard Test Method | Test Conditions | Note | Number of Damaged |
|---|--------------------------|---|-------------------------|----------------------|
| Resistance to Soldering Heat | JEITA ED-4701 300 302 | Tsld=260±5°C,10sec 3mm from the base of the epoxy bulb | 1 time | 0/100 |
| Solder ability | JEITA ED-4701 300 303 | Tsld=235±5°C,5sec(using flux) | 1time over 95% | 0/100 |
| Thermal Shock | JEITA ED-4701 300 307 | 0°C~100°C 15sec,15sec | 100 cycles | 0/100 |
| Temperature Cycle | JEITA ED-4701 100 105 | -40°C~25°C~100°C~25°C 30min,5min,30min,5min | 100 cycles | 0/100 |
| Moisture Resistance Cycle | JEITA ED-4701 200 203 | 25°C~65°C~-10°C 90%RH 24hrs/1cycle | 10 cycles | 0/100 |
| High Temperature Storage | JEITA ED-4701 200 201 | Ta=100°C | 1000hrs | 0/100 |
| Terminal Strength (Pull test) | JEITA ED-4701 400 401 | Load 10N (1kgf) 10±1sec | No noticeable damage | 0/100 |
| Terminal Strength (bending test) | JEITA ED-4701 400 401 | Load 5N (0.5kgf) 0°~90°~0° bend 2 times | No noticeable damage | 0/100 |
| Temperature Humidity Storage | JEITA ED-4701 100 103 | Ta=60°C,RH=90% | 1000hrs | 0/100 |
| Low Temperature Storage | JEITA ED-4701 200 202 | Ta=−40°C | 1000hrs | 0/100 |
| Steady State Operating Life | | Ta=25°C, IF=30mA | 1000hrs | 0/100 |
| Steady State Operating Life of High Humidity Heat | | Ta=60°C,RH=90%,IF=30mA | 500hrs | 0/100 |
| Steady State Operating Life of Low Temperature | | Ta=-30°C, IF=20mA | 1000hrs | 0/100 |

2)Criteria For Judging The Damage:

| Item | Symbol | Test Conditions | Criteria for Judgment | | |
|--------------------|--------|-----------------|-----------------------|------------|--|
| | | | Min | Max | |
| Forward Voltage | VF | IF=20mA | — | F.V.*)×1.1 | |
| Reverse Current | IR | VR=5V | | F.V.*)×2.0 | |
| Luminous Intensity | IV | IF=20mA | F.V.*)×0.7 | | |

*)F.V.: First Value.





Spec No: U508 Approved: ZHOU Lucky Light Electronics Co., Ltd. Rev No: V.2 Date: Dec/22/2005 Checked: Wu

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Please read the following notes before using the datasheets:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30° C or less and 70° RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

3. Soldering Condition

- 3.1 Pb-free solder temperature profile
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260°C for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

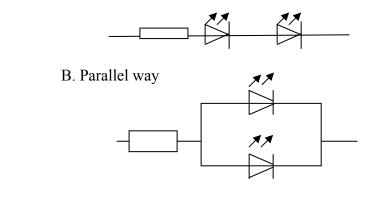
Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

7. Propose operation method:

7.1 The DC drive current of LED should be between 10 to 20mA no matter for single LED or multiple LEDs.

7.2Drive circuit:

A. Series connection





7.3 The pulse will destroy the fixed inner connection of LED, so the circuit must be designed carefully. When circuit open or close, LED will not be assaulted over-pressed (over-flow).

7.4 In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, we should know well about the drive method and condition of the application. If there is no special requirement from customer, we will ensure the uniformity of LEDs at 20mA binning.

7.5 If want to have the uniform luminance and color, please use the same binning current with our company. And avoid using intermix to cause the differences of luminance and color.